# **HMC733\* PRODUCT PAGE QUICK LINKS**

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# COMPARABLE PARTS -

View a parametric search of comparable parts.

### **EVALUATION KITS**

· HMC733LC4B Evaluation Board

### **DOCUMENTATION**

#### **Data Sheet**

• HMC733 Data Sheet

# REFERENCE MATERIALS 🖵

#### **Quality Documentation**

- Package/Assembly Qualification Test Report: LC4, LC4B (QTR: 2014-00380 REV: 01)
- Semiconductor Qualification Test Report: GaAs HBT-A (QTR: 2013-00228)

# **DESIGN RESOURCES**

- HMC733 Material Declaration
- PCN-PDN Information
- · Quality And Reliability
- Symbols and Footprints

### **DISCUSSIONS**

View all HMC733 EngineerZone Discussions.

## SAMPLE AND BUY

Visit the product page to see pricing options.

# TECHNICAL SUPPORT 🖳

Submit a technical question or find your regional support number.

### DOCUMENT FEEDBACK 🖳

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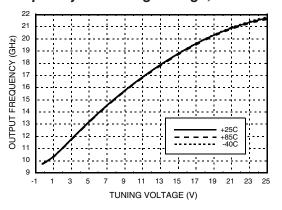


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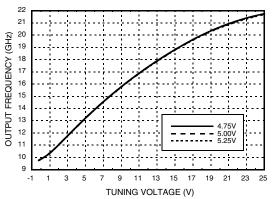


# WIDEBAND MMIC VCO w/ BUFFER AMPLIFIER, 10 - 20 GHz

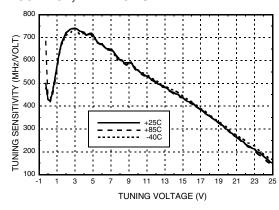
### Frequency vs. Tuning Voltage, Vcc = +5V



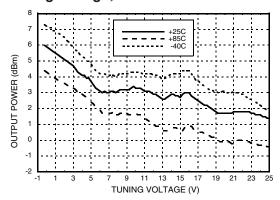
### Frequency vs. Tuning Voltage, T = +25 °C



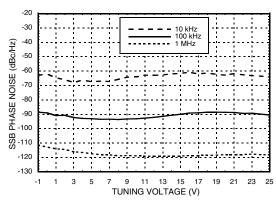
### Sensitivity vs. Tuning Voltage, Vcc= +5V, T = +25 °C



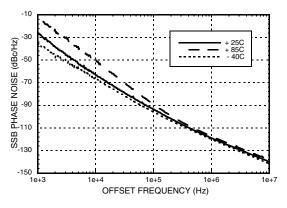
Output Power vs.
Tuning Voltage, Vcc= +5V



# SSB Phase Noise vs. Tuning Voltage, T = +25 °C



# Typical SSB Phase Noise vs. Temperature Vtune = +10V

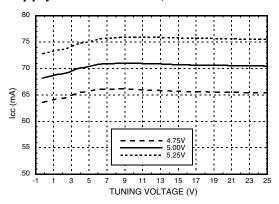






# WIDEBAND MMIC VCO w/ BUFFER AMPLIFIER, 10 - 20 GHz

### Supply Current vs. Vcc, T = +25 °C





### **Absolute Maximum Ratings**

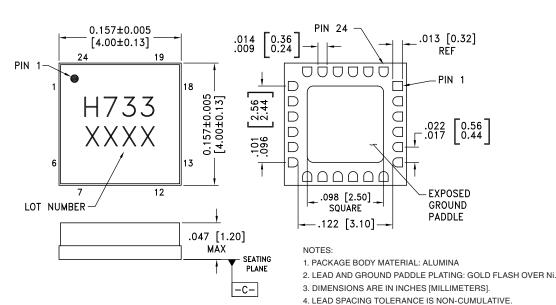
Vcc	+5.5 Vdc
Vtune	-1.0 to +25V
Storage Temperature	-65 to +150 °C
ESD Sensitivity (HBM)	Class 1A

### Reliability Information

Junction Temperature To Maintain 1 Million Hour MTTF	135 °C
Nominal Junction Temperature (T = 85 °C)	119 °C
Thermal Resistance (Junction to GND paddle, 5V supply)	97 °C/W
Operating Temperature	-40 °C to +85 °C

### **Outline Drawing**

### **BOTTOM VIEW**



## Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [2]
HMC733LC4B	Alumina, White	Gold over Nickel	MSL3 <sup>[1]</sup>	H733 XXXX

- [1] Max peak reflow temperature of 260 °C
- [2] 4-Digit lot number XXXX

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5. PACKAGE WARP SHALL NOT EXCEED 0.05mm DATUM -C-6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED

TO PCB RF GROUND.



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# WIDEBAND MMIC VCO w/ BUFFER AMPLIFIER, 10 - 20 GHz

### **Pin Descriptions**

Pin Number	Function	Description	Interface Schematic
1 - 3, 5 - 11, 13, 17 - 24	N/C	No Connection. These pins may be connected to RF/DC ground. Performance will not be affected.	
4	Vtune	Control Voltage and Modulation Input. Modulation bandwidth dependent on drive source impedance.	Vtune 0 50  5 1.4 pF
12	Vcc	Supply Voltage Vcc= +5V	Vcc 0 20 12 pF 27pF
14, 16	GND	Package bottom has an exposed metal paddle that must also be RF & DC grounded.	⊖ GND =
15	RFOUT	RF output (AC coupled)	RFOUT

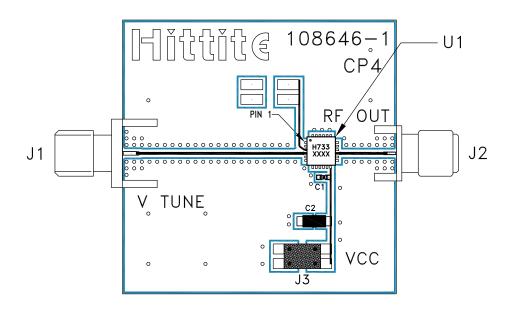


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# WIDEBAND MMIC VCO w/ BUFFER AMPLIFIER, 10 - 20 GHz

### **Evaluation PCB**



### List of Materials for Evaluation PCB 108648 [1]

Item	Description
J1	PCB Mount SMA RF Connector, Johnson
J2	PCB Mount SMA Connector, SRI
J3	DC Header
C1	1000 pF Capacitor, 0402 Pkg.
C2	4.7 μF Capacitor, Tantalum
U1	HMC733LC4B VCO
PCB <sup>[2]</sup>	108646 Eval Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed ground paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.







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